

INTERCONNECTS

SERIES 335, 364, 435, 464 • .100" GRID (.018" DIA. PINS), LOW PROFILE • SINGLE AND DOUBLE ROW STRIPS

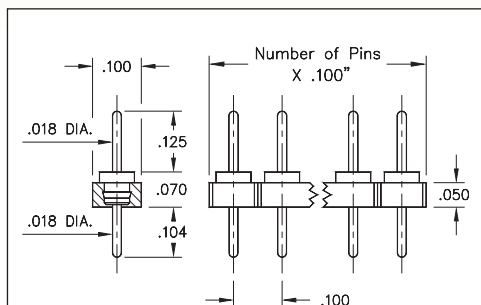


FIG. 1

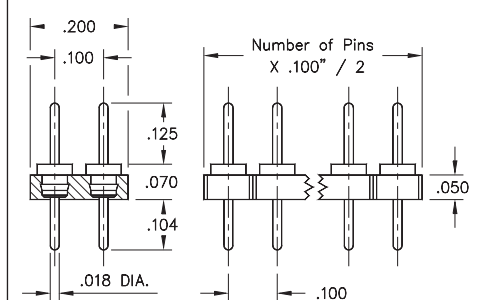


FIG. 2

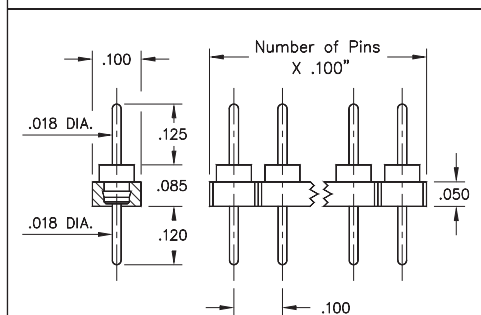


FIG. 3

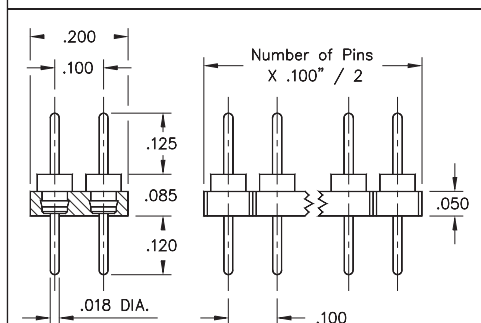
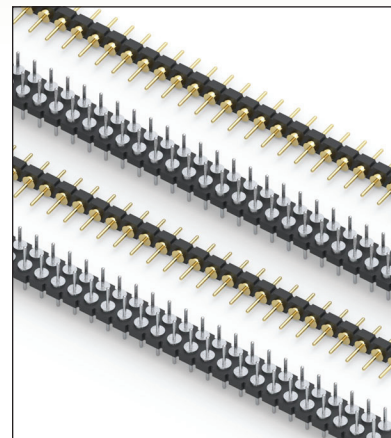


FIG. 4

- Series 335 and 435 single and double row PCB interconnects offer a .070" profile, the lowest available
- Series 364 and 464 single and double row PCB interconnects offer .085" profile above board
- Series 335 and 435 use MM #3516 pins. See page 212 for details
- Series 364 and 464 use MM #6458 pins. See page 213 for details
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION

FIG. 1	Series 335...160	Single Row .070" Profile Pin Header			
	335-XX-1	-00-160000	Specify number of pins 01-32		
FIG. 2	Series 435...160	Double Row .070" Profile Pin Header			
	435-XX-2	-00-160000	Specify number of pins 04-72		
FIG. 3	Series 364...580	Single Row .085" Profile Pin Header			
	364-10-1	-00-580000	Specify number of pins 01-32		
FIG. 4	Series 464...580	Double Row .085" Profile Pin Header			
	464-10-2	-00-580000	Specify number of pins 04-72		
RoHS - 2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264					
SPECIFY PLATING CODE XX=		10	90	40	
Pin Plating 		10 μ" Au	200 μ" Sn/Pb	200 μ" Sn	